



# FSA2267 / FSA2267A

## 0.35Ω Low-Voltage Dual-SPDT Analog Switch

### Features

- Typical 0.35Ω On Resistance ( $R_{ON}$ ) for +2.7V supply
- FSA2267A features less than 10μA  $I_{CCT}$  current when S Input is lower than  $V_{CC}$
- 0.25Ω maximum  $R_{ON}$  flatness for +2.7V supply
- 1.6mm x 2.1mm 10-Lead MicroPak™ package
- Broad  $V_{CC}$  operating range
- Low THD (0.02% typical for 32Ω load)
- High current handling capability (350mA continuous current under 3.3V supply)

### Applications

- Cell phone
- PDA
- Portable media player

### Description

The FSA2267 and FSA2267A are Dual Single Pole Double Throw (SPDT) analog switches. The FSA2267 operates from a single 1.65V to 3.6V supply, while the FSA2267A operates from a single 2.3V to 4.3V supply. Each features an ultra-low On Resistance of 0.35Ω at a +2.7V supply and 25°C. Both devices are fabricated with sub-micron CMOS technology to achieve fast switching speeds and designed for break-before-make operation.

FSA2267A features very low quiescent current, even when the control voltage is lower than the  $V_{CC}$  supply. This feature services the mobile handset applications very well allowing for the direct interface with baseband processor general purpose I/Os.

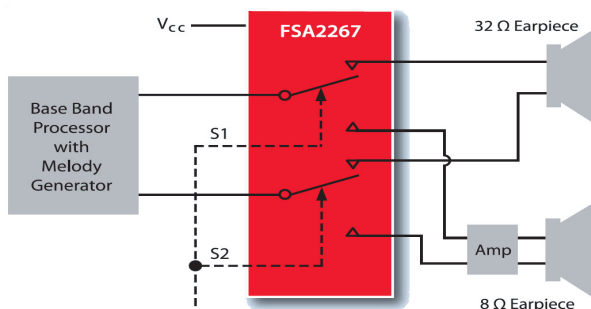
### Ordering Information

Order Number	Package Number	Product Code Top Mark	Lead-Free	Package Description	Packing Method
FSA2267L10X	MAC010A	FC	Yes	10-Lead MicroPak, 1.6 x 2.1mm, JEDEC MO-255	5K Units on Tape and Reel
FSA2267MUX (Preliminary)	MUA10A	FSA 2267	Yes	10-Lead Molded Small Outline Package (MSOP), JEDEC MO-187, 3.0mm Wide	3K Units on Tape and Reel
FSA2267AL10X	MAC010A	FD	Yes	10-Lead MicroPak, 1.6 x 2.1mm JEDEC MO-255	5K Units on Tape and Reel
FSA2267AMUX (Preliminary)	MUA10A	FSA 2267A	Yes	10-Lead Molded Small Outline Package (MSOP), JEDEC MO-187, 3.0mm Wide	3K Units on Tape and Reel

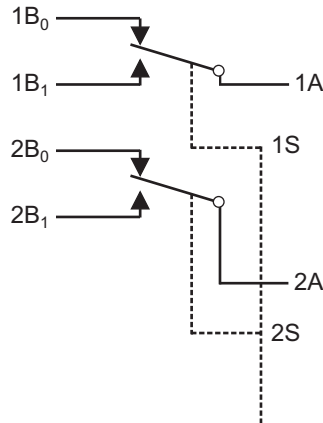
Pb-Free package per JEDEC J-STD-020B.

MicroPak™ is a trademark of Fairchild Semiconductor Corporation.

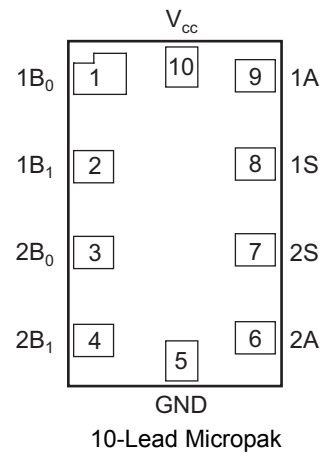
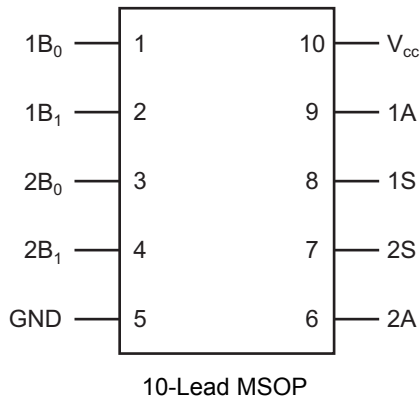
### Application Diagram



## Analog Symbols



## Connections Diagram



## Truth Table

Control Input(s)	Function
LOW Logic Level	B <sub>0</sub> Connected to A
HIGH Logic Level	B <sub>1</sub> Connected to A

## Pin Descriptions

Pin Names	Function
1A, 2A, 1B <sub>0</sub> , 1B <sub>1</sub> , 2B <sub>0</sub> , 2B <sub>1</sub>	Data Ports
1S, 2S	Control Input

## Absolute Maximum Ratings

The “Absolute Maximum Ratings” are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The “Recommended Operating Conditions” table defines the conditions for actual device operation.

Symbol	Parameter	Min.	Max.	Unit
$V_{CC}$	Supply Voltage	-0.5	+4.6	V
$V_S$	Switch Voltage <sup>(1)</sup>	-0.5	$V_{CC} + 0.5$	V
$V_{IN}$	Input Voltage <sup>(1)</sup>	-0.5	+4.6	V
	Input Diode Current <sup>(2)</sup>	-50		mA
	Switch Current		350	mA
	Peak Switch Current (Pulsed at 1ms duration, <10% Duty Cycle)		500	mA
$T_{STG}$	Storage Temperature Range	-65	+150	°C
$T_J$	Maximum Junction Temperature		+150	°C
$T_L$	Lead Temperature (Soldering, 10 seconds)		+260	°C
ESD	Human Body Model: FSA2267		7500	V
	Human Body Model: FSA2267A		7000	V
	Charge Device Model: FSA2267/FSA2267A		1000	V

### Notes:

- The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.
- Minimums define the acceptable range of current. Negative current should not exceed minimum negative values.

## Recommended Operating Conditions

Symbol	Parameter	Min.	Max.	Unit
$V_{CC}$	Supply Voltage			V
	FSA2267	1.65	3.6	V
	FSA2267A	2.3	4.3	
$V_{IN}$	Control Input Voltage <sup>(3)</sup>	0	$V_{CC}$	V
$V_{SW}$	Switch Input Voltage	0	$V_{CC}$	V
$T_A$	Operating Temperature	-40	+85	°C

### Notes:

- Unused inputs must be held HIGH or LOW. They may not float.

## ESD Protection

### ESD Performance of the FSA2267/FSA2267A

#### FSA2267

- HBM all pins 7.0kV
- CDM all pins 1.0kV

#### FSA267A

- HBM all pins 7.5kV
- CDM all pins 1.0kV

### Human Body Model

Figure 1 shows the schematic representation of the Human Body Model ESD event. Figure 2 is the ideal waveform representation of the Human Body Model. The device is tested to JEDEC: JESD22-A114 Human Body Model.

### Charged Device Model

In manufacturing test and handling environments, a more useful model is the Charged Device Model and the FSA2267/FSA2267A has a very good ESD immunity to this model. The device is tested to JEDEC: JESD-C101 Charged Device Model.

### IEC 61000-4-2

The IEC 61000-4-2 standard covers ESD testing and performance of finished equipment and evaluates the equipment in its entirety for ESD immunity. Fairchild Semiconductor has evaluated this device using the IEC 6100-4-2 representative system model depicted in Figure 3.

ESD values measured via the IEC 61000-4-2 evaluation method are influenced by the specific board layout, board size, and many other factors of the manufacturer's product application. Measured system ESD values cannot be guaranteed by Fairchild Semiconductor to exactly correlate to a manufacturer's in-house testing due to these application environment variables. Fairchild Semiconductor has been able to determine that, for ultra-portable applications, an enhanced ESD immunity, relative to the IEC 61000-4-2 specification, can be achieved with the inclusion of a 100Ω-series resistor in the V<sub>CC</sub> supply path to the analog switch (see Figure 4). Typical improvements of between 3-6kV of ESD immunity (I/O to GND) have been measured with the inclusion of the resistor with the IEC 61000-4-2 representative model. For more information on ESD testing methodologies, please refer to:

*AN-6019 Fairchild Analog Switch Products ESD Test Methodology Overview*  
<http://www.fairchildsemi.com/an/AN/AN-6019.pdf>

### Additional ESD Test Conditions

For information regarding test methodologies and performance levels, please contact Fairchild Semiconductor.

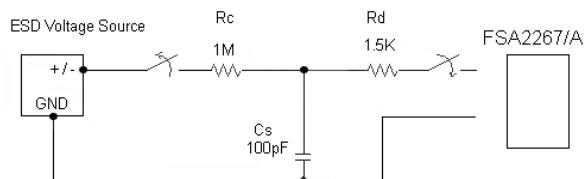


Figure 1. Human Body ESD Test Model

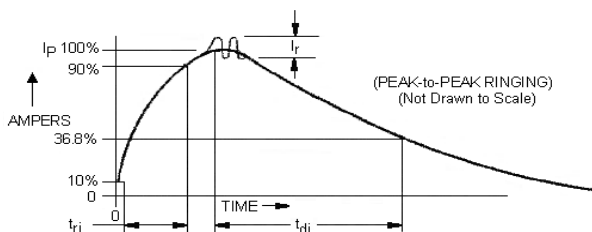


Figure 2. HBM Current Waveform

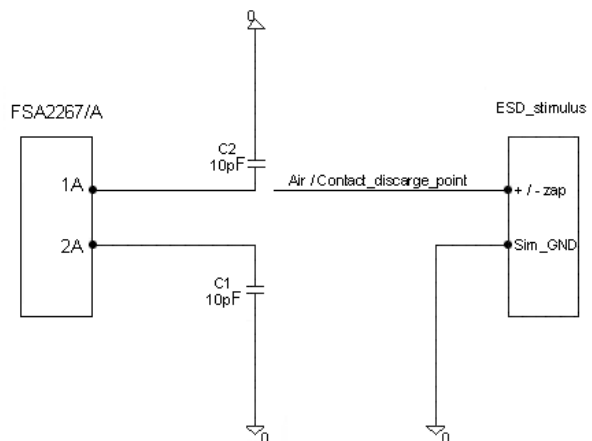


Figure 3. IEC 61000-4-2 ESD Test Model

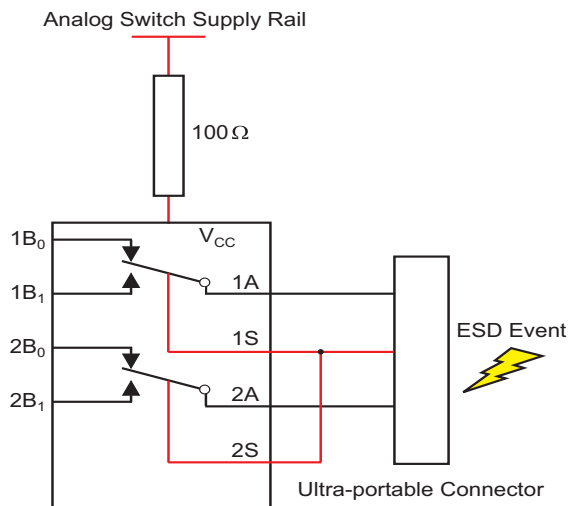


Figure 4. ESD Immunity with 100Ω Resistor

## FSA2267 DC Electrical Characteristics

All typical values are at 25°C unless otherwise specified.

Symbol	Parameter	Conditions	V <sub>CC</sub>	T <sub>A</sub> = +25°C			T <sub>A</sub> = -40 to +85°C		Units
			(V)	Min.	Typ.	Max.	Min.	Max.	
V <sub>IH</sub>	Input Voltage High		2.7 to 3.6				2.0		V
			2.3 to 2.7				1.7		
			1.65 to 1.95				0.65 V <sub>CC</sub>		
V <sub>IL</sub>	Input Voltage Low		2.7 to 3.6					0.8	V
			2.3 to 2.7					0.7	
			1.65 to 1.95					0.35 V <sub>CC</sub>	
I <sub>IN</sub>	Control Input Leakage	V <sub>IN</sub> = 0V to V <sub>CC</sub>	1.65 to 3.6				-0.5	0.5	μA
I <sub>NO(OFF)</sub> , I <sub>NC(OFF)</sub>	OFF-Leakage Current of Port nB <sub>0</sub> and nB <sub>1</sub>	nA = 0.3V, 3.3V, nB <sub>0</sub> or nB <sub>1</sub> = 0.3V, 3.3V or floating	3.6	-5.0		5.0	-50	50	nA
		nA = 0.3V, 2.4V, nB <sub>0</sub> or nB <sub>1</sub> = 0.3V, 2.4V or floating	2.7	-5.0		5.0	-50	50	
		nA = 0.3V, 1.65V, nB <sub>0</sub> or nB <sub>1</sub> = 0.3V, 1.65V or floating	1.95	-5.0		5.0	-50	50	
I <sub>A(ON)</sub>	ON Leakage Current of Port 1A and 2A	nA = 0.3V, 3.3V, nB <sub>0</sub> or nB <sub>1</sub> = 0.3V, 3.3V or floating	3.6	-5.0		5.0	-50	50	nA
		nA = 0.3V, 2.4V, nB <sub>0</sub> or nB <sub>1</sub> = 0.3V, 2.4V or floating	2.7	-5.0		5.0	-50	50	
		nA = 0.3V, 1.65V, nB <sub>0</sub> or nB <sub>1</sub> = 0.3V, 1.65V or floating	1.95	-5.0		5.0	-50	50	
R <sub>ON</sub>	Switch On Resistance <sup>(4)</sup> See Figure 5	I <sub>OUT</sub> = 100mA, nB <sub>0</sub> or nB <sub>1</sub> = 0V, 0.7V, 2.0V, 2.7V	2.7		0.35			0.60	Ω
		I <sub>OUT</sub> = 100mA, nB <sub>0</sub> or nB <sub>1</sub> = 0V, 0.7V, 1.6V, 2.3V	2.3		0.45			0.75	
		I <sub>OUT</sub> = 100mA, nB <sub>0</sub> or nB <sub>1</sub> = 0.8V	1.65		1.0			3.9	
ΔR <sub>ON</sub>	On Resistance Matching Between Channels <sup>(5)</sup>	I <sub>OUT</sub> = 100mA, nB <sub>0</sub> or nB <sub>1</sub> = 0.7V	2.7		0.040			0.075	Ω
			2.3		0.040			0.080	
			1.65		0.1				
R <sub>FLAT(ON)</sub>	On Resistance Flatness <sup>(6)</sup>	I <sub>OUT</sub> = 100mA, nB <sub>0</sub> or nB <sub>1</sub> = 0V to V <sub>CC</sub>	2.7					0.25	Ω
			2.3					0.3	
			1.65		0.3				
I <sub>CC</sub>	Quiescent Supply Current	V <sub>IN</sub> = 0V or V <sub>CC</sub> , I <sub>OUT</sub> = 0A	3.6	-100		100	-500	500	nA

4. On Resistance is determined by the voltage drop between A and B pins at the indicated current through the switch.

5. ΔR<sub>ON</sub> = R<sub>ONmax</sub> - R<sub>ONmin</sub> measured at identical V<sub>CC</sub>, temperature, and voltage.

6. Flatness is defined as the difference between the maximum and minimum value of R<sub>ON</sub> over the specified range of conditions.

## FSA2267A DC Electrical Characteristics

All typical values are at 25°C unless otherwise specified.

Symbol	Parameter	Conditions	V <sub>CC</sub>	T <sub>A</sub> = +25°C			T <sub>A</sub> = -40 to +85°C		Units
			(V)	Min.	Typ.	Max.	Min.	Max.	
V <sub>IH</sub>	Input Voltage High		3.6 to 4.3				1.7		V
			2.7 to 3.6				1.5		
			2.3 to 2.7				1.4		
V <sub>IL</sub>	Input Voltage Low		3.6 to 4.3					0.7	V
			2.7 to 3.6					0.5	
			2.3 to 2.7					0.4	
I <sub>IN</sub>	Control Input Leakage	V <sub>IN</sub> = 0V to V <sub>CC</sub>	2.3 to 4.3				-0.5	0.5	μA
I <sub>NO(OFF)</sub> , I <sub>NC(OFF)</sub>	OFF-Leakage Current of Port nB <sub>0</sub> and nB <sub>1</sub>	nA = 0.3V, 4.0V, nB <sub>0</sub> or nB <sub>1</sub> = 4.0V, 0.3V or floating	4.3	-10.0		10.0	-100	100	nA
		nA = 0.3V, 3.3V, nB <sub>0</sub> or nB <sub>1</sub> = 0.3V, 3.3V or floating	3.6	-5.0		5.0	-50	50	
		nA = 0.3V, 2.4V, nB <sub>0</sub> or nB <sub>1</sub> = 0.3V, 2.4V or floating	2.7	-5.0		5.0	-50	50	
I <sub>A(ON)</sub>	ON Leakage Current of Port 1A and 2A	nA = 0.3V, 4.0V, nB <sub>0</sub> or nB <sub>1</sub> = 0.3V, 4.0V or floating	4.3	-20.0		20.0	-200	200	nA
		nA = 0.3V, 3.3V, nB <sub>0</sub> or nB <sub>1</sub> = 0.3V, 3.3V or floating	3.6	-5.0		5.0	-50	50	
		nA = 0.3V, 3.3V, nB <sub>0</sub> or nB <sub>1</sub> = 0.3V, 3.3V or floating	2.7	-5.0		5.0	-50	50	
R <sub>ON</sub>	Switch On Resistance <sup>(7)</sup>	I <sub>OUT</sub> = 100mA, nB <sub>0</sub> or nB <sub>1</sub> = 0V, 0.7V, 3.6V, 4.3V	4.3		0.35			0.6	Ω
		I <sub>OUT</sub> = 100mA, nB <sub>0</sub> or nB <sub>1</sub> = 0V, 0.7V, 2.3V, 3.0V	3.0		0.35			0.6	
		I <sub>OUT</sub> = 100mA, nB <sub>0</sub> or nB <sub>1</sub> = 0V, 0.7V, 2.0V, 2.7V	2.7		0.35			0.6	
		I <sub>OUT</sub> = 100mA, nB <sub>0</sub> or nB <sub>1</sub> = 0.8V	1.65		1.0				
ΔR <sub>ON</sub>	On Resistance Matching Between Channels <sup>(8)</sup> See Figure 6	I <sub>OUT</sub> = 100mA, nB <sub>0</sub> or nB <sub>1</sub> = 0.7V	4.3		0.04			0.075	Ω
			3.0		0.04			0.075	
			2.7		0.04			0.075	
			1.65		0.1				
R <sub>FLAT(ON)</sub>	On Resistance Flatness <sup>(9)</sup>	I <sub>OUT</sub> = 100mA, nB <sub>0</sub> or nB <sub>1</sub> = 0V to V <sub>CC</sub>	4.3		0.15			0.25	Ω
			3.0		0.15			0.25	
			2.7		0.15			0.25	
			1.65		0.3				
I <sub>CC</sub>	Quiescent Supply Current	V <sub>IN</sub> = 0V or V <sub>CC</sub> , I <sub>OUT</sub> = 0A	4.3	-100	80	100	-500	500	nA
I <sub>CCT</sub>	Increase in I <sub>CC</sub> per Input	V <sub>IN</sub> = 1.8V	4.3		7.0	10.0		15.0	μA
		V <sub>IN</sub> = 2.6V			0.5	2.0		7.0	

7. On Resistance is determined by the voltage drop between A and B pins at the indicated current through the switch.

8. ΔR<sub>ON</sub> = R<sub>ONmax</sub> - R<sub>ONmin</sub> measured at identical V<sub>CC</sub>, temperature, and voltage.

9. Flatness is defined as the difference between the maximum and minimum value of R<sub>ON</sub> over the specified range of conditions.

## FSA2267 AC Electrical Characteristics

All typical values are at 25°C unless otherwise specified.

Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	T <sub>A</sub> = +25°C			T <sub>A</sub> = -40 to +85°C		Units	Figure Number
				Min.	Typ.	Max.	Min.	Max.		
t <sub>ON</sub>	Turn ON Time	nB <sub>0</sub> or nB <sub>1</sub> = 1.5V, R <sub>L</sub> = 50Ω, C <sub>L</sub> = 35 pF	2.7 to 3.6		30.0	38.0		42.0	ns	Figure 7
			2.3 to 2.7		29.0	37.0		40.0		
			1.65 to 1.95		27.0	35.0		38.0		
t <sub>OFF</sub>	Turn OFF Time	nB <sub>0</sub> or nB <sub>1</sub> = 1.5V, R <sub>L</sub> = 50Ω, C <sub>L</sub> = 35 pF	2.7 to 3.6		13.0	16.0		18.0	ns	Figure 7
			2.3 to 2.7		14.0	18.0		20.0		
			1.65 to 1.95		15.0	21.0		25.0		
t <sub>B-M</sub>	Break-Before-Make Time	nB <sub>0</sub> or nB <sub>1</sub> = 1.5V, R <sub>L</sub> = 50Ω, C <sub>L</sub> = 35 pF	2.7 to 3.6		17.0		2.0		ns	Figure 8
			2.3 to 2.7		15.0		2.0			
			1.65 to 1.95		12.0		2.0			
Q	Charge Injection	C <sub>L</sub> = 100 pF, V <sub>GEN</sub> = 0V, R <sub>GEN</sub> = 0Ω	2.7 to 3.6		9.0				pC	Figure 10
		C <sub>L</sub> = 100 pF, V <sub>GEN</sub> = 0V, R <sub>GEN</sub> = 0Ω	2.3 to 2.7		9.0					
		C <sub>L</sub> = 100 pF, V <sub>GEN</sub> = 0V, R <sub>GEN</sub> = 0Ω	1.65 to 1.95		9.0					
OIRR	OFF-Isolation	f = 100kHz, R <sub>L</sub> = 50Ω, C <sub>L</sub> = 5 pF (Stray)	2.7 to 3.6		-80.0				dB	Figure 9
			2.3 to 2.7		-80.0					
			1.65 to 1.95		-80.0					
Xtalk	Crosstalk	f = 100kHz, R <sub>L</sub> = 50Ω, C <sub>L</sub> = 5 pF (Stray)	2.7 to 3.6		-80.0				dB	Figure 9
			2.3 to 2.7		-80.0					
			1.65 to 1.95		-80.0					
BW	-3db Bandwidth	R <sub>L</sub> = 50Ω	1.65 to 3.6		45.0			MHz	Figure 12	
THD	Total Harmonic Distortion	R <sub>L</sub> = 32Ω, V <sub>IN</sub> = 2V <sub>pk-pk</sub> , f = 20Hz to 20kHz	2.7 to 3.6		0.024				%	Figure 13
		R <sub>L</sub> = 32Ω, V <sub>IN</sub> = 1.5V <sub>pk-pk</sub> , f = 20Hz to 20kHz	2.3 to 2.7		0.015					
		R <sub>L</sub> = 32Ω, V <sub>IN</sub> = 1.2V <sub>pk-pk</sub> , f = 20Hz to 20kHz	1.65 to 1.95		0.35					

## FSA2267A AC Electrical Characteristics

All typical value are at 25°C unless otherwise specified.

Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	T <sub>A</sub> = +25°C			T <sub>A</sub> = -40 to +85°C		Units	Figure Number
				Min.	Typ.	Max.	Min.	Max.		
t <sub>ON</sub>	Turn ON Time	nB <sub>0</sub> or nB <sub>1</sub> = 1.5V, R <sub>L</sub> = 50Ω, C <sub>L</sub> = 35pF	3.6 to 4.3		37.0	46.0		48.0	ns	Figure 7
			2.7 to 3.6		37.0	50.0		57.0		
			2.3 to 2.7		60					
			1.65		570					
t <sub>OFF</sub>	Turn OFF Time	nB <sub>0</sub> or nB <sub>1</sub> = 1.5V, R <sub>L</sub> = 50Ω, C <sub>L</sub> = 35pF	3.6 to 4.3		15.0	23.0		25.0	ns	Figure 7
			2.7 to 3.6		16.0	30.0		30.0		
			2.3 to 2.7		50.0					
			1.65		500					
t <sub>B-M</sub>	Break-Before-Make Time	nB <sub>0</sub> or nB <sub>1</sub> = 1.5V, R <sub>L</sub> = 50Ω, C <sub>L</sub> = 35pF	3.6 to 4.3		8.0		2.0	ns	Figure 8	
			2.7 to 3.6		8.0		2.0			
			2.3 to 2.7		8.0		2.0			
Q	Charge Injection	C <sub>L</sub> = 100 pF, V <sub>GEN</sub> = 0V, R <sub>GEN</sub> = 0Ω	3.6 to 4.3		24.0			pC	Figure 10	
		C <sub>L</sub> = 100 pF, V <sub>GEN</sub> = 0V, R <sub>GEN</sub> = 0Ω	2.7 to 3.6		24.0					
		C <sub>L</sub> = 100 pF, V <sub>GEN</sub> = 0V, R <sub>GEN</sub> = 0Ω	2.3 to 2.7		24.0					
OIRR	OFF-Isolation	f = 100kHz, R <sub>L</sub> = 50Ω, C <sub>L</sub> = 5pF (Stray)	3.6 to 4.3		-75.0			dB	Figure 9	
			2.7 to 3.6		-75.0					
			2.3 to 2.7		-75.0					
Xtalk	Crosstalk	f = 100kHz, R <sub>L</sub> = 50Ω, C <sub>L</sub> = 5pF (Stray)	3.6 to 4.3		-70.0			dB	Figure 9	
			2.7 to 3.6		-70.0					
			2.3 to 2.7		-70.0					
BW	-3db Bandwidth	R <sub>L</sub> = 50Ω	2.3 to 4.3		45.0			MHz	Figure 12	
THD	Total Harmonic Distortion	R <sub>L</sub> = 32Ω, V <sub>IN</sub> = 2V <sub>pk-pk</sub> , f = 20Hz to 20kHz	3.6 to 4.3		0.02			%	Figure 13	
		R <sub>L</sub> = 32Ω, V <sub>IN</sub> = 1.5V <sub>pk-pk</sub> , f = 20Hz to 20kHz	2.7 to 3.6		0.02					
		R <sub>L</sub> = 32Ω, V <sub>IN</sub> = 1.2V <sub>pk-pk</sub> , f = 20Hz to 20kHz	2.3 to 2.7		0.02					

## Capacitance

Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	T <sub>A</sub> = +25°C			T <sub>A</sub> = -40 to +85°C		Units	Figure Number
				Min.	Typ.	Max.	Min.	Max.		
C <sub>IN</sub>	Control Pin Input Capacitance	f=1Mhz	0.0		1.5				pF	Figure 11
C <sub>OFF</sub>	B Port OFF Capacitance	f=1Mhz	3.3		30.0				pF	Figure 11
C <sub>ON</sub>	A Port ON Capacitance	f=1Mhz	3.3		126				pF	Figure 11



## Typical Characteristics

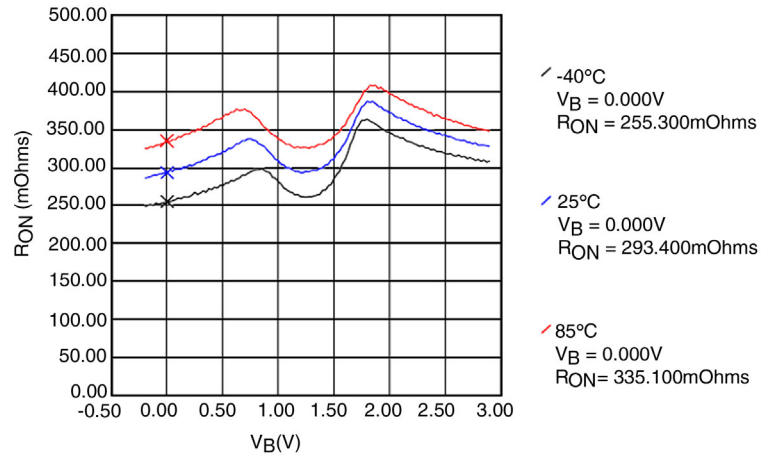


Figure 5.  $R_{ON}$  at 2.7V for FSA2267

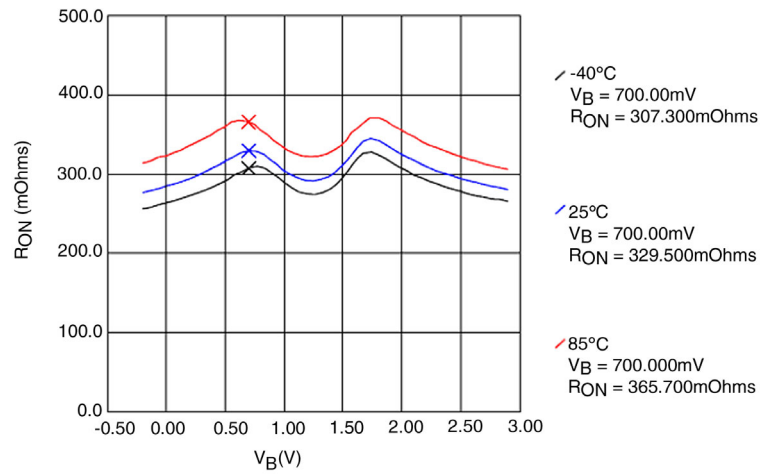
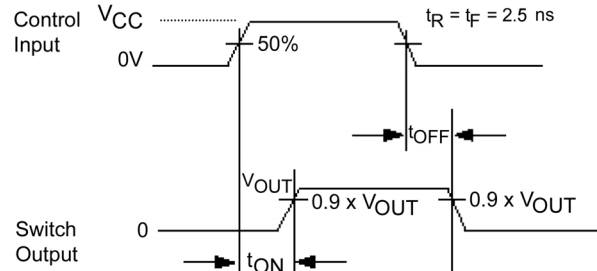
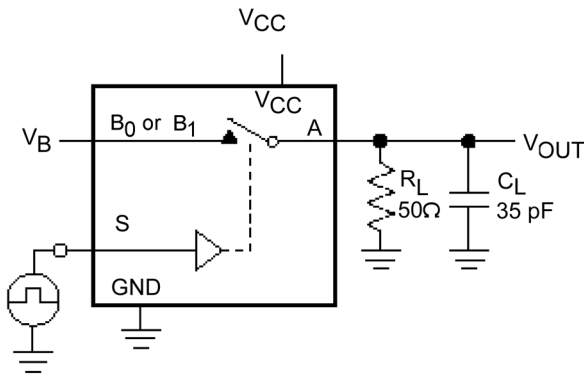


Figure 6.  $R_{ON}$  at 2.7V for FSA2267A

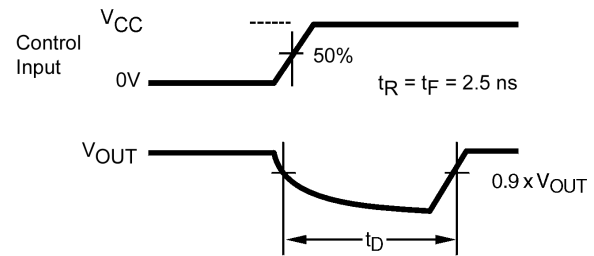
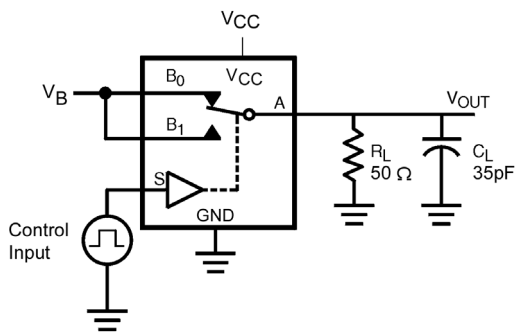
### AC Loading and Waveforms



$C_L$  includes Fixture and Stray Capacitance.

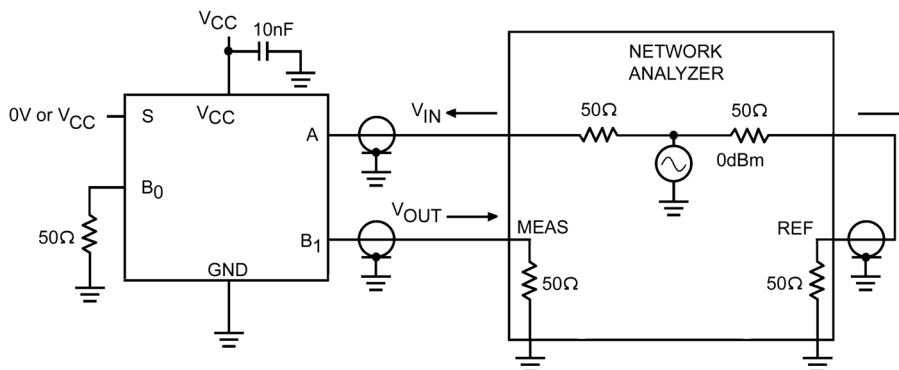
Logic input waveforms are inverted for switches with opposite logic sense.

**Figure 7. Turn-On/Turn-Off Timing**



$C_L$  Includes Fixture and Stray Capacitance

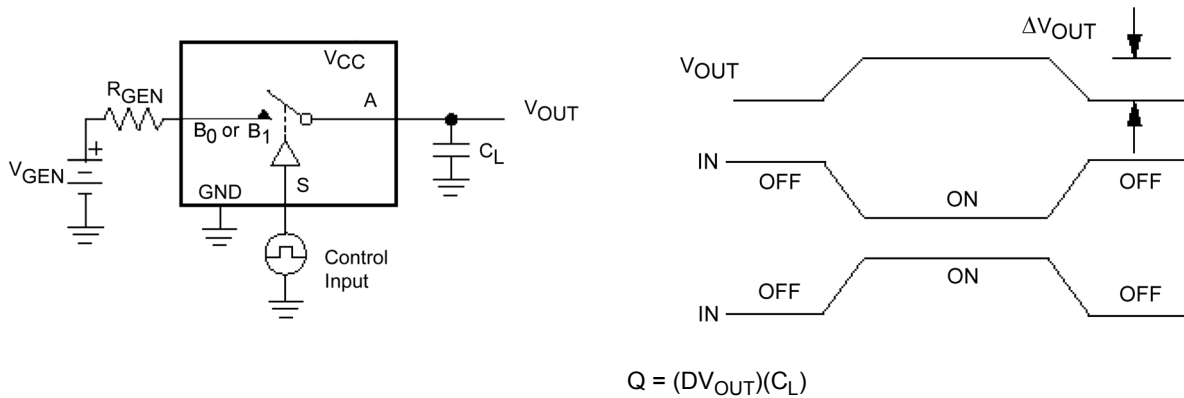
**Figure 8. Break-Before-Make Timing**



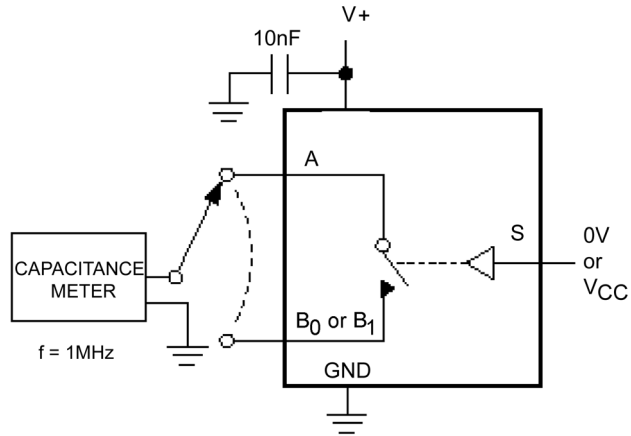
$$\begin{aligned} \text{OFF-ISOLATION} &= 20 \log \frac{V_{OUT}}{V_{IN}} \\ \text{ON-LOSS} &= 20 \log \frac{V_{OUT}}{V_{IN}} \\ \text{CROSSTALK} &= 20 \log \frac{V_{OUT}}{V_{IN}} \end{aligned}$$

**Figure 9. OFF Isolation and Crosstalk**

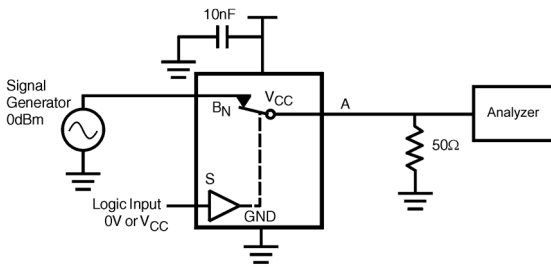
**AC Loading and Waveforms (Continued)**



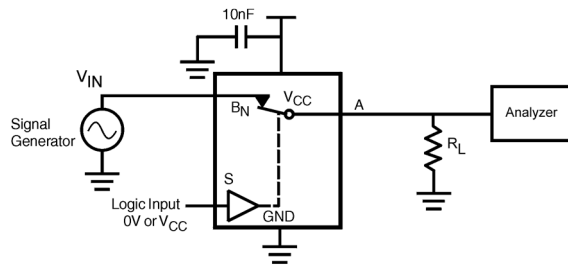
**Figure 10. Charge Injection**



**Figure 11. ON/OFF Capacitance Measurement Setup**



**Figure 12. Bandwidth**



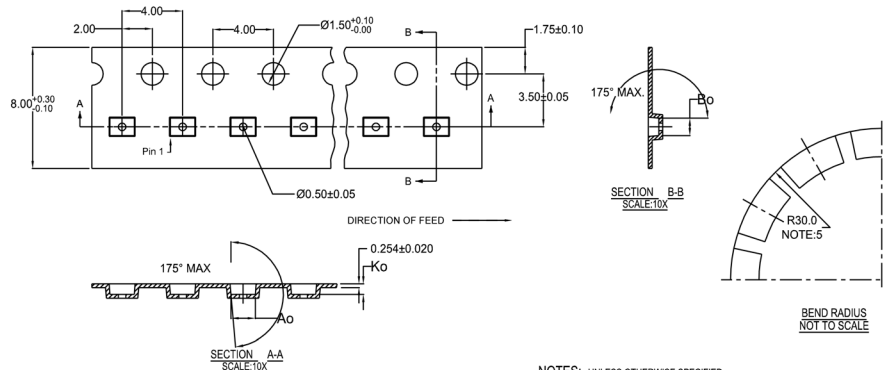
**Figure 13. Harmonic Distortion**

## Tape and Reel Specification

### Tape Format For MicroPak 10

Dimensions are in millimeters (inches) unless otherwise noted.

Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Tape Status
L10X	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed



10	300056	2.30±0.05	1.78±0.05	0.68±0.05
8	300038	1.78±0.05	1.78±0.05	0.68±0.05
6	300033	1.60±0.05	1.15±0.05	0.70±0.05

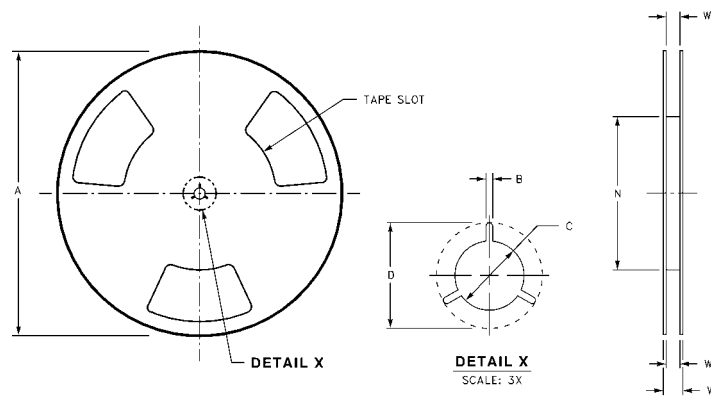
NOTES: UNLESS OTHERWISE SPECIFIED

1. ACCUMULATED 50 SPROCKETS, SPROCKET HOLE PITCH IS 200.00 ±0.30MM
2. NO INDICATED CORNER RADIUS IS 0.127MM
3. CAMBER NOT TO EXCEED 1MM IN 100MM
4. SMALLEST ALLOWABLE BENDING RADIUS
5. POCKET POSITION RELATIVE TO SPROCKET HOLE MEASURED AS TRUE POSITION OF POCKET, NOT POCKET HOLE



SCALE: 6X

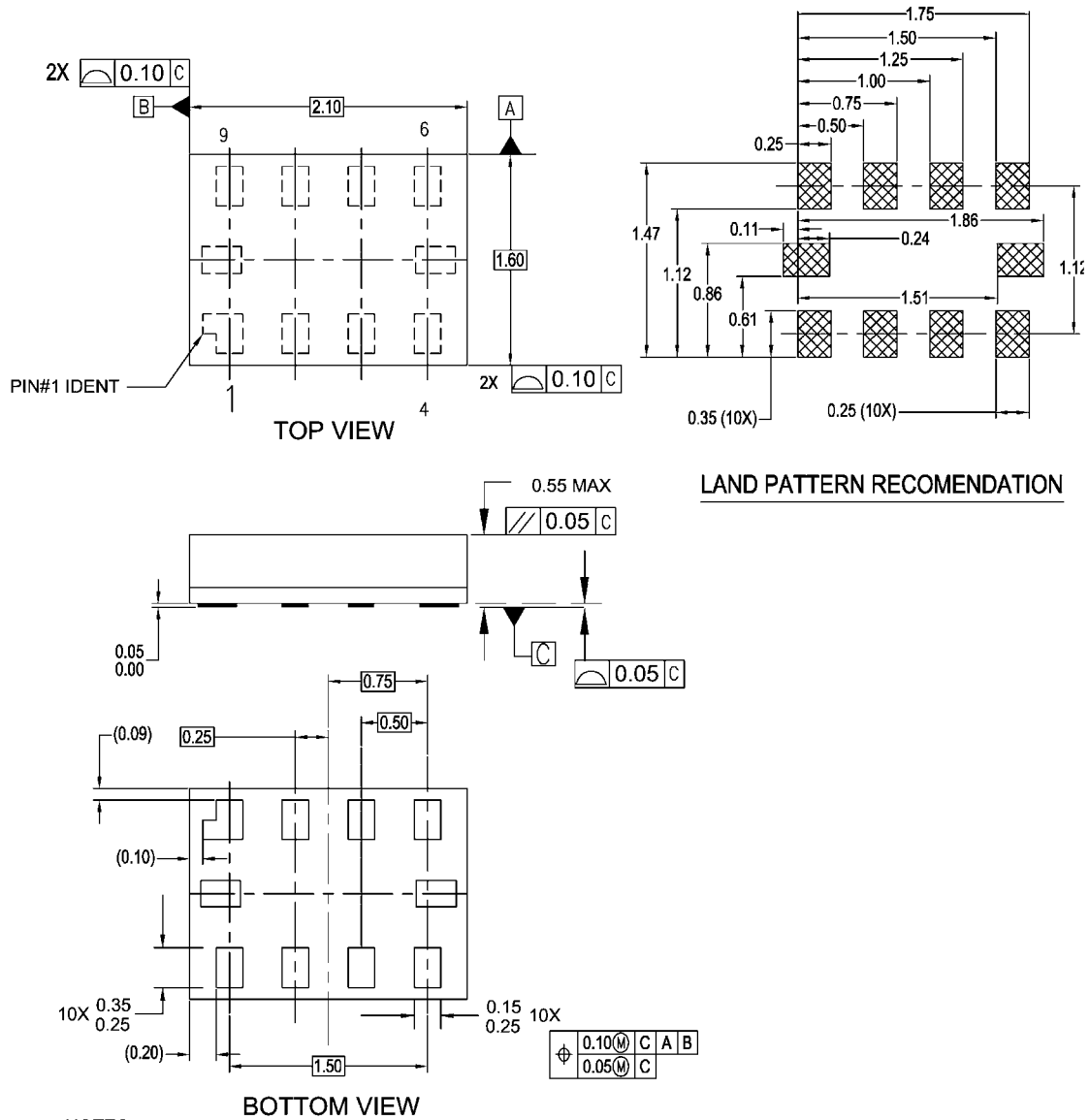
### Reel Dimensions



Tape Size	A	B	C	D	N	W1	W2	W3
8 mm	7.0	0.059	0.512	0.795	2.165	0.331 + 0.059/-0.000	0.567	W1 + 0.078/-0.039
	(177.8)	(1.50)	(13.00)	(20.20)	(55.00)	(8.40 + 1.50/-0.00)	(14.40)	(W1 + 2.00/-1.00)

## Physical Dimensions

Dimensions are in millimeters unless otherwise noted.



### NOTES:

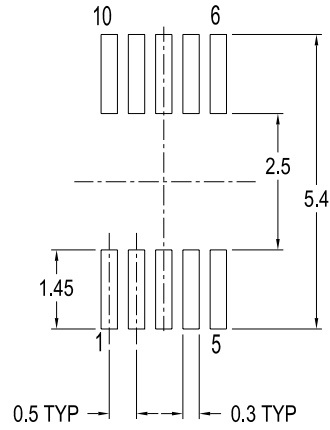
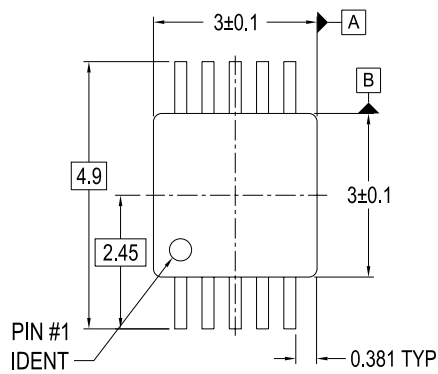
- A. PACKAGE CONFORMS TO JEDEC MO255, VARIATION UABD
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES CONFORMS TO ASME Y14.5M, 1994.

MAC010ARevC

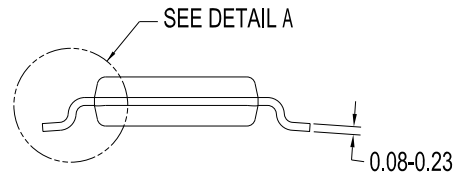
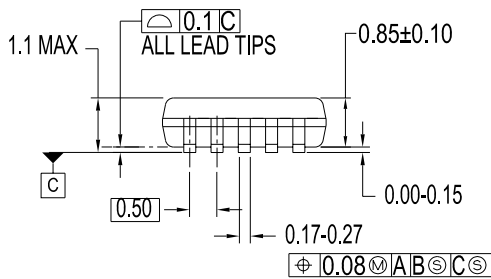
Figure 14. Pb-Free 10-Lead MicroPak, 1.6 x 2.1mm

## Physical Dimensions

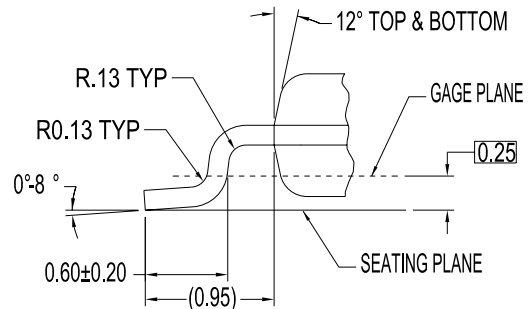
Dimensions are in millimeters unless otherwise noted.



LAND PATTERN RECOMMENDATION



DIMENSIONS ARE IN MILLIMETERS



DETAIL A

**NOTES:**

- A. CONFORMS TO JEDEC REGISTRATION MO-187, VARIATION BA, REF NOTE 6, DATE 11/00.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.

MUA10AREVA

**Figure 15. Pb-Free 10-Lead Molded Small Outline Package (MSOP), JEDEC MO-187, 3.0mm wide**

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ActiveArray <sup>™</sup>	GlobalOptoisolator <sup>™</sup>	OCXPro <sup>™</sup>	SMART START <sup>™</sup>	UltraFET <sup>®</sup>
Bottomless <sup>™</sup>	GTO <sup>™</sup>	OPTOLOGIC <sup>®</sup>	SPM <sup>™</sup>	VCX <sup>™</sup>
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CoolFET <sup>™</sup>	I <sup>2</sup> C <sup>™</sup>	PACMAN <sup>™</sup>	SuperFET <sup>™</sup>	
CROSSVOLT <sup>™</sup>	i-Lo <sup>™</sup>	POP <sup>™</sup>	SuperSOT <sup>™</sup> -3	
DOME <sup>™</sup>	ImpliedDisconnect <sup>™</sup>	Power247 <sup>™</sup>	SuperSOT <sup>™</sup> -6	
EcoSPARK <sup>™</sup>	IntelliMAX <sup>™</sup>	PowerEdge <sup>™</sup>	SuperSOT <sup>™</sup> -8	
E <sup>2</sup> CMOS <sup>™</sup>	ISOPLANAR <sup>™</sup>	PowerSaver <sup>™</sup>	SyncFET <sup>™</sup>	
EnSigna <sup>™</sup>	LittleFET <sup>™</sup>	PowerTrench <sup>®</sup>	TCM <sup>™</sup>	
FACT <sup>™</sup>	MICROCOUPLER <sup>™</sup>	QFET <sup>®</sup>	TinyBoost <sup>™</sup>	
FAST <sup>®</sup>	MicroFET <sup>™</sup>	QS <sup>™</sup>	TinyBuck <sup>™</sup>	
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FRFET <sup>™</sup>	MSX <sup>™</sup>	RapidConfigure <sup>™</sup>	TinyLogic <sup>®</sup>	
	MSXPro <sup>™</sup>	RapidConnect <sup>™</sup>	TINYOPTO <sup>™</sup>	
Across the board. Around the world. <sup>™</sup>		μSerDes <sup>™</sup>	TruTranslation <sup>™</sup>	
The Power Franchise <sup>®</sup>		ScalarPump <sup>™</sup>	UHC <sup>™</sup>	
Programmable Active Droop <sup>™</sup>				

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